## **AN3122**

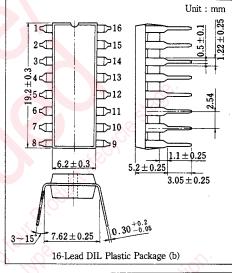
### RF Converter Circuit

#### Outline

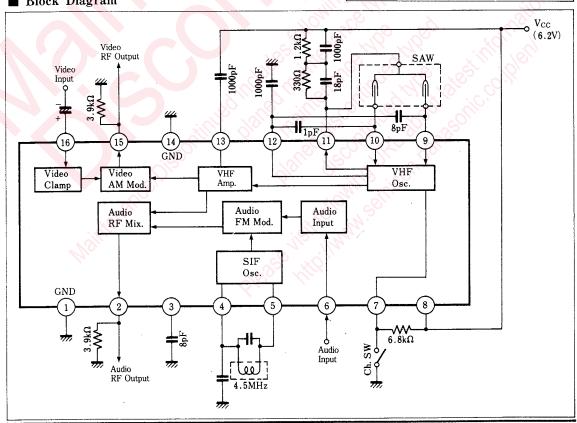
The AN3122 is an integrated circuit designed for VHF band RF converter.

#### **■** Features

- VHF oscillator requires no adjustment.
- Low power consumption.
- Incorporates a white clip circuit.



#### ■ Block Diagram



#### ■ Pin

Pin No.	Pin Name	Pin No.	Pin Name		
1	GND	9	VHF Osc. Base (1)		
2	Audio RF Output	10	VHF Osc. Base (2)		
3	Audio Level Control	11	VHF Osc. Collector		
4	SIF Osc. (1)	12	VHF Osc. Emitter		
5	SIF Osc. (2)	13	VHF Amp. By-pass		
6	Audio Input	14	GND		
7	ch. SW.	15	Video RF Output		
8	Vcc	16	Video Input		

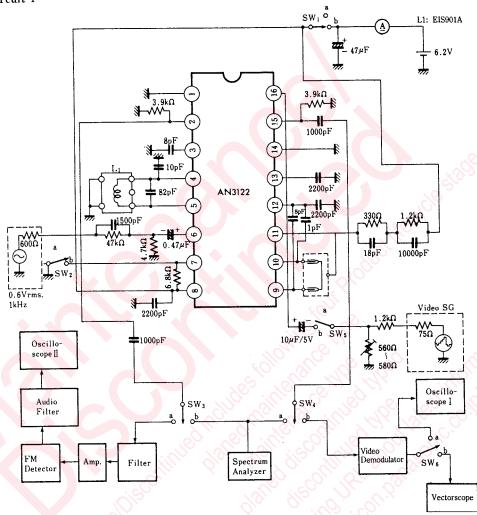
### ■ Absolute Maximum Ratings (Ta=25°C)

Item	Symbol	Rating	Unit	
Supply voltage	$V_{cc}$	9	V V	
Supply current	$I_{CC}$	45	mA	
Power dissipation	$P_{\mathrm{D}}$	400	mW	
Operating ambient temperature	$T_{ m opr}$	-20~+75	°C	
Storage temperature	$T_{ m stg}$	-55~+150	°C	

## ■ Electrical Characteristics (Vcc=6.2V, Ta=25°C)

Item	Symbol	Test Circuit	Cindition	min.	typ.	max.	Unit
Supply current	$I_{CC}$	1		17	22	29	mA
Video carrier wave output level	$V_{P}$	1	18 18 18 18 19 19 19 19 19 19 19 19 19 19 19 19 19	84	86	88	dBμ
Max. video modulation degree	m <sub>max.</sub>	1	Chin Sall Sill Sills	90	93	00	αDμ %
Video modulation degree	m	1	$V_{in} = 0.48V_{p-p}$	70	75	80	%
Sync. distortion	Sync	10	10 10 10 10 10 10 10 10 10 10 10 10 10 1	-8.5		+4	%
Differential gain	DG	i	m=75%	-5	3)	+5	<del>70</del>
Differential phase	DP	1	m=75%	-5	<b>)</b>	+5	
Video modulation degree inter-channel difference	⊿m	1	10 23:	-3		+3	ueg.
Sound sub-carrier wave output level	$V_{s}$	1	6. 6. 6 °C	75.5		79.5	
Sound FM modulation sensitivity	⊿f <sub>FM</sub>	1	$A_{in}=600 \text{mV}_{rms}$	±19.9	4.9E 0		$\frac{dB\mu}{dB\mu}$
Sound S/N ratio	SN <sub>S</sub>	1	TAIR GOOTHY (MS	55	±25.0	±31.3	$\frac{\text{kHz}}{\text{dB}}$

Test Circuit 1



Measuring Conditions List

<b>.</b>		Switch Operation					Managing Instrument		
Item		SW1	SW 2	SW3	SW4	SW 5	SW6	Measuring Instrument	
$I_{CC}$	10/1	b	a/b	_	7/2	11.7	_	DC ammeter	
$V_P$	M.	b	b	a	∠ea .	b	-	Spectrum analyzer	
mmax		b	b	a	a	b	_	Spectrum analyzer	
m		b	b	a	а	b	-	Spectrum analyzer	
Sync		b	b	_	b	b	а	Oscilloscope I	
DG		Ъ	b		b	b	b	Vectorscope	
DP		b	b		b	b	b	Vectorscope	
 ∆m		ь	b	a	a	b	_	Spectrum analyzer	
$V_S$		b	b	b	а	a	_	Spectrum analyzsr	
$\Delta f_{FM}$		b	b	a		a	_	FM linear detector	
$\overline{\mathrm{SN_S}}$		b	b	a	_		_	Oscilloscope II	

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